

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

NEC

The μ PA1728 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

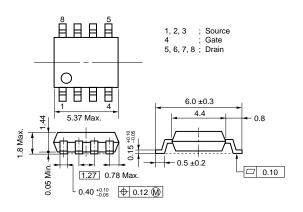
FEATURES

- Single chip type
- Low on-state resistance $R_{DS(on)1} = 19 \text{ m}\Omega \text{ TYP.}$ (VGs = 10 V, ID = 4.5 A) $R_{DS(on)2} = 23 \text{ m}\Omega \text{ TYP.}$ (VGs = 4.5 V, ID = 4.5 A)
- $R_{DS(on)3} = 24 \text{ m}\Omega \text{ TYP.} (V_{GS} = 4.0 \text{ V}, \text{ ID} = 4.5 \text{ A})$
- Low Ciss: Ciss = 1700 pF TYP.
- Built-in G-S protection diode
- Small and surface mount package (Power SOP8)

★ ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1728G	Power SOP8

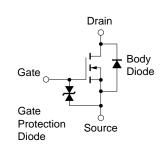
PACKAGE DRAWING (Unit: mm)



ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC)	ID(DC)	±9	А
Drain Current (Pulse) ^{Note1}	D(pulse)	±36	А
Total Power Dissipation $(T_A = 25^{\circ}C)^{Note2}$	P⊤	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to + 150	°C
Single Avalanche Current Note3	las	9	А
Single Avalanche Energy Note3	Eas	81	mJ





Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

- 2. Mounted on ceramic substrate of 1200 mm² x 2.2 mm
- 3. Starting T_{ch} = 25°C, V_{DD} = 30 V, R_G = 25 Ω , T_{GS} = 20 \rightarrow 0 V

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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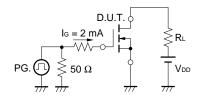
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vds = 60 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	yfs	V _{DS} = 10 V, I _D = 4.5 A	6.0	12		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = 10 V$, $I_D = 4.5 A$		19	26	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 4.5 A		23	29	mΩ
	RDS(on)3	Vgs = 4.0 V, Id = 4.5 A		24	34	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		1700		pF
Output Capacitance	Coss	V _{GS} = 0 V		270		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		130		pF
Turn-on Delay Time	td(on)	VDD = 30 V, ID = 4.5 A		17		ns
Rise Time	tr	Vgs = 10 V		69		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		77		ns
Fall Time	tr			31		ns
Total Gate Charge	QG	V _{DD} = 48 V		31		nC
Gate to Source Charge	QGS	Vgs = 10 V		4.4		nC
Gate to Drain Charge	Qgd	ID = 9 A		9.1		nC
Body Diode Forward Voltage	VF(S-D)	IF = 9 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 9 A, VGS = 0 V		41		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ µs		76		nC

ELECTRICAL CHARACTERISTICS (T_A = 25°C, All terminals are connected.)

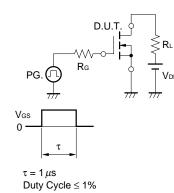
TEST CIRCUIT 1 AVALANCHE CAPABILITY

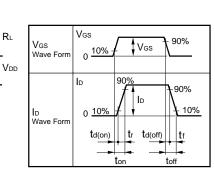
$PG. \qquad PG. \qquad PG. \qquad Vot = 20 \rightarrow 0 \text{ V} \qquad Has \qquad Vot = 20 \rightarrow 0 \text{ V} \qquad Has \qquad Vot = 10 \text{ V} \text$

TEST CIRCUIT 3 GATE CHARGE



TEST CIRCUIT 2 SWITCHING TIME





TYPICAL CHARACTERISTICS ($T_A = 25^{\circ}C$)

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T_A = 25°C Single Pulse hited.

VDS - Drain to Source Voltage - V

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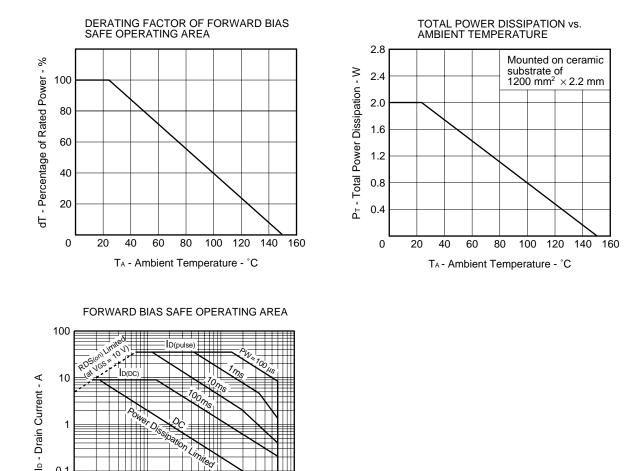
10

100

1

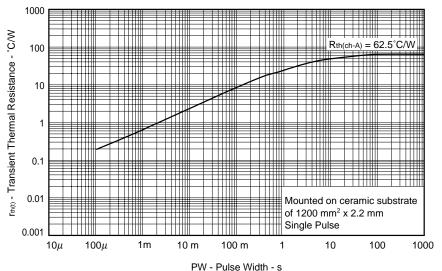
0.1

0.01 0.1

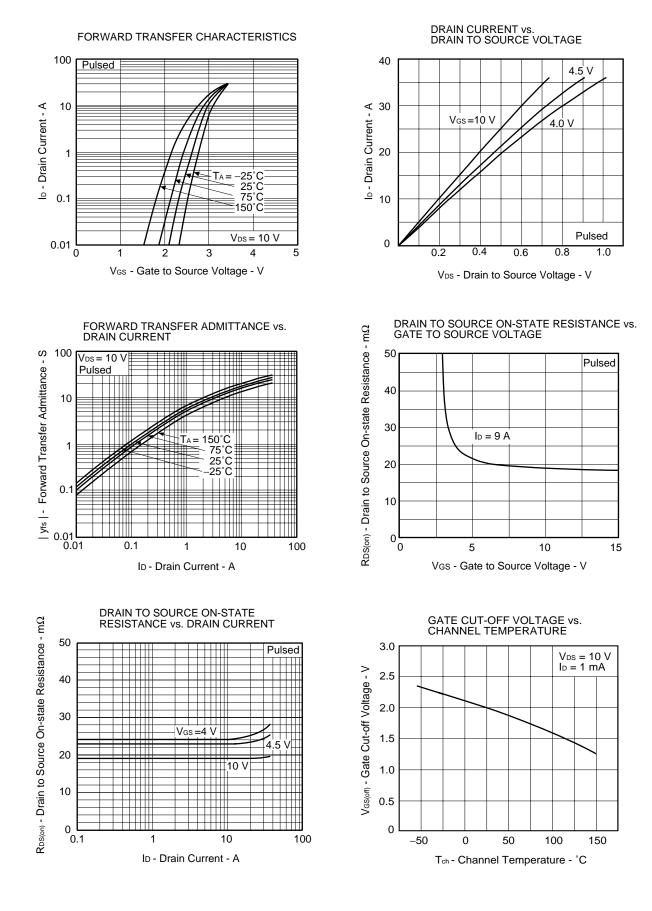


Remark

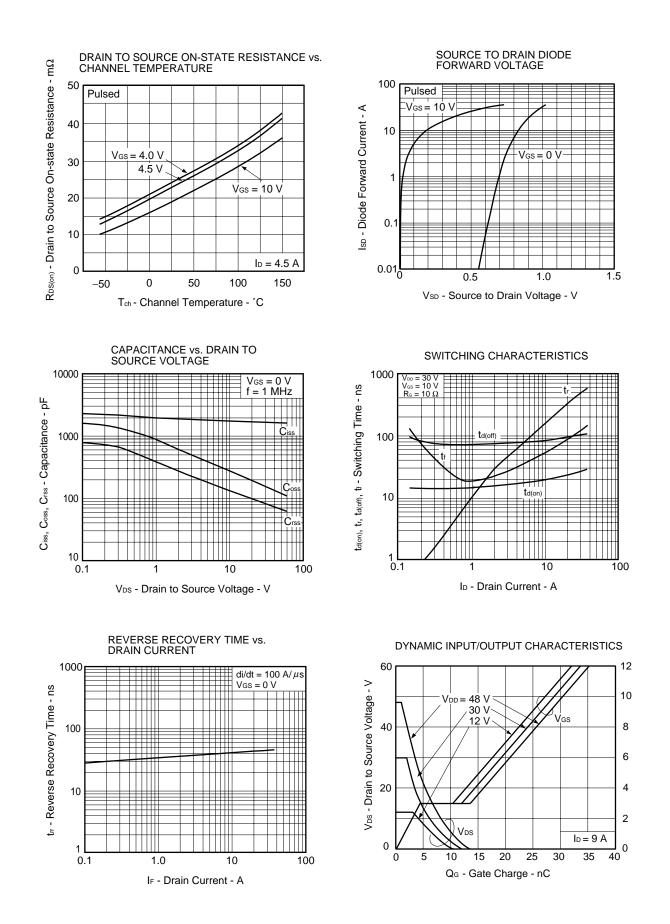
Mounted on ceramic substrate of 1200 mm² x 2.2 mm



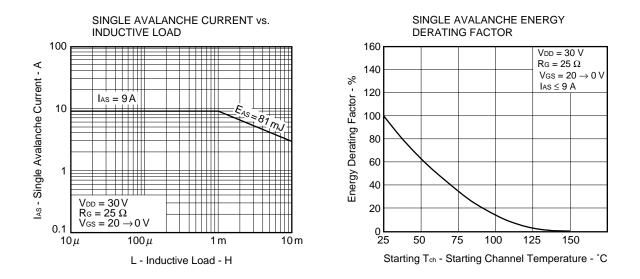
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



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